# 74LVC3G17

# Triple non-inverting Schmitt trigger with 5 V tolerant input Rev. 10 — 6 July 2012 Product data s

**Product data sheet** 

#### 1. **General description**

The 74LVC3G17 provides three non-inverting buffers with Schmitt trigger input. It is capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of the 74LVC3G17 as a translator in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

#### **Features and benefits** 2.

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant input/output for interfacing with 5 V logic
- High noise immunity
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- $\pm$  24 mA output drive (V<sub>CC</sub> = 3.0 V)
- CMOS low-power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

# **Applications**

Wave and pulse shapers for highly noisy environments



# Triple non-inverting Schmitt trigger with 5 V tolerant input

# 4. Ordering information

Table 1. Ordering information

Type number	Package							
	Temperature range	Name	Description	Version				
74LVC3G17DP	–40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2				
74LVC3G17DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1				
74LVC3G17GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 $\times$ 1.95 $\times$ 0.5 mm	SOT833-1				
74LVC3G17GF	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 $\times$ 1 $\times$ 0.5 mm	SOT1089				
74LVC3G17GD	–40 °C to +125 °C	XSON8U	plastic extremely thin small outline package; no leads; 8 terminals; UTLP based; body $3\times2\times0.5$ mm	SOT996-2				
74LVC3G17GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 $\times$ 1.6 $\times$ 0.5 mm	SOT902-2				
74LVC3G17GN	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.2 $\times$ 1.0 $\times$ 0.35 mm	SOT1116				
74LVC3G17GS	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 $\times$ 1.0 $\times$ 0.35 mm	SOT1203				

# 5. Marking

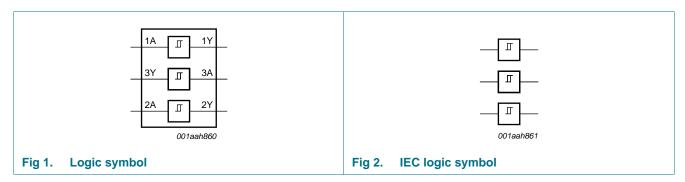
Table 2. Marking codes

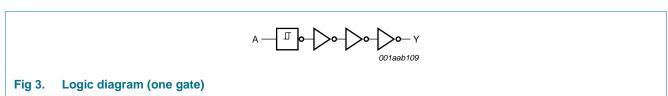
Type number	Marking code <sup>[1]</sup>
74LVC3G17DP	V17
74LVC3G17DC	V17
74LVC3G17GT	V17
74LVC3G17GF	VV
74LVC3G17GD	V17
74LVC3G17GM	V17
74LVC3G17GN	VV
74LVC3G17GS	VV

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

# Triple non-inverting Schmitt trigger with 5 V tolerant input

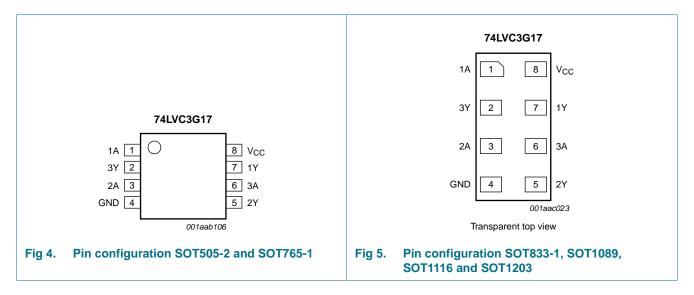
# 6. Functional diagram



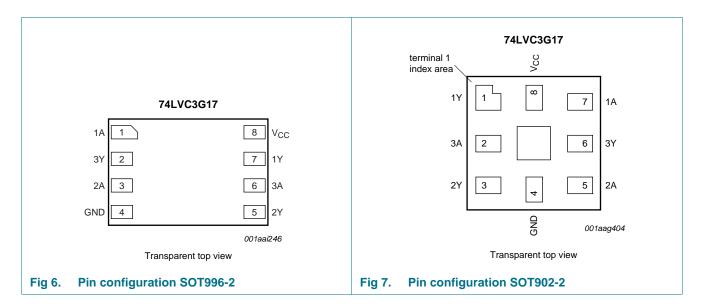


# 7. Pinning information

# 7.1 Pinning



# Triple non-inverting Schmitt trigger with 5 V tolerant input



# 7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description	
	SOT505-2, SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203	SOT902-2	
1A, 2A, 3A	1, 3, 6	7, 5, 2	data input
GND	4	4	ground (0 V)
1Y, 2Y, 3Y	7, 5, 2	1, 3, 6	data output
$V_{CC}$	8	8	supply voltage

# 8. Functional description

Table 4. Function table [1]

Input	Output
nA	nY
L	L
Н	Н

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level.

#### Triple non-inverting Schmitt trigger with 5 V tolerant input

# 9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
$V_{I}$	input voltage		[ <u>1]</u> -0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
Vo	output voltage	Active mode	[ <u>1]</u> -0.5	$V_{CC} + 0.5$	V
		Power-down mode	[1][2] -0.5	+6.5	V
Io	output current	$V_O = 0 V to V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[3] _	250	mW

<sup>[1]</sup> The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 10. Recommended operating conditions

Table 6. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		1.65	5.5	V
VI	input voltage		0	5.5	V
Vo	output voltage		0	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C

<sup>[2]</sup> When  $V_{CC} = 0 \text{ V}$  (Power-down mode), the output voltage can be 5.5 V in normal operation.

<sup>[3]</sup> For TSSOP8 package: above 55 °C the value of P<sub>tot</sub> derates linearly with 2.5 mW/K.
For VSSOP8 package: above 110 °C the value of P<sub>tot</sub> derates linearly with 8 mW/K.
For XSON8, XSON8U and XQFN8 packages: above 118 °C the value of P<sub>tot</sub> derates linearly with 7.8 mW/K.

# Triple non-inverting Schmitt trigger with 5 V tolerant input

# 11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T <sub>amb</sub> = -	40 °C to +85 °C					
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{T+}$ or $V_{T-}$				
		$I_O$ = 100 $\mu$ A; $V_{CC}$ = 1.65 $V$ to 5.5 $V$	-	-	0.1	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.3	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	V
		$I_O = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.55	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{T+}$ or $V_{T-}$				
		$I_O = -100 \mu A$ ; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	V <sub>CC</sub> - 0.1	-	-	V
		$I_O = -4 \text{ mA}$ ; $V_{CC} = 1.65 \text{ V}$	1.2	-	-	V
		$I_{O} = -8 \text{ mA}$ ; $V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_O = -12 \text{ mA}$ ; $V_{CC} = 2.7 \text{ V}$	2.2	-	-	V
		$I_O = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.3	-	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.8	-	-	V
   <sub> </sub>	input leakage current	$V_1 = 5.5 \text{ V or GND}; V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	[2] -	±0.1	±5	μА
OFF	power-off leakage current	$V_1$ or $V_0 = 5.5$ V; $V_{CC} = 0$ V	-	±0.1	±10	μA
Icc	supply current	V <sub>I</sub> = 5.5 V or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 1.65 V to 5.5 V	-	0.1	10	μA
Δl <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V}$	[2] _	5	500	μΑ
Cı	input capacitance		-	3.5	-	pF
	40 °C to +125 °C					•
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{T+}$ or $V_{T-}$				
-		$I_O = 100 \mu A$ ; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	-	-	0.1	V
		$I_O = 4 \text{ mA}$ ; $V_{CC} = 1.65 \text{ V}$	-	-	0.70	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	-	0.60	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	-	0.80	V
		I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V	-	-	0.80	V
V <sub>OH</sub>	HIGH-level output voltage	$V_1 = V_{T+}$ or $V_{T-}$				
011	1 0	$I_{O} = -100 \mu A$ ; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	V <sub>CC</sub> - 0.1	-	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	0.95	-	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.7	-	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	1.9	_	-	V
		$I_0 = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.0	_	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.4	_	-	V
		$V_1 = 5.5 \text{ V or GND}$ ; $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	<b>U.</b> 1			

74LVC3G17

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#### Triple non-inverting Schmitt trigger with 5 V tolerant input

 Table 7.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$I_{OFF}$	power-off leakage current	$V_I$ or $V_O = 5.5 \text{ V}$ ; $V_{CC} = 0 \text{ V}$	-	-	±20	μΑ
I <sub>CC</sub>	supply current	$V_I = 5.5 \text{ V or GND}; I_O = 0 \text{ A};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	-	-	40	μΑ
$\Delta I_{CC}$	additional supply current	$V_1 = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 2.3 \text{ V} \text{ to } 5.5 \text{ V}$	-	-	5	mA

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

# 12. Dynamic characteristics

#### Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

•		,,							
Symbol	Parameter	Conditions	-4	-40 °C to +85 °C			-40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max		
$t_{pd}$	propagation delay	nA to nY; see Figure 8	1						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.5	5.6	10.5	1.5	13.1	ns	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	3.7	6.5	1.0	8.5	ns	
		$V_{CC} = 2.7 \text{ V}$	1.0	3.8	6.5	1.0	8.5	ns	
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	3.6	5.7	1.0	7.1	ns	
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	1.0	2.7	4.3	1.0	5.4	ns	
$C_{PD}$	power dissipation capacitance	per buffer; $V_{CC} = 3.3 \text{ V}$ ; $V_I = \text{GND to } V_{CC}$	<u> </u>	16.3	-	-	-	pF	

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

 $f_o$  = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma (C_L \times V_{CC}{}^2 \times f_o) = sum \ of \ outputs.$ 

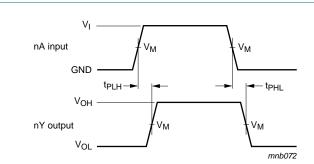
<sup>[2]</sup> These typical values are measured at  $V_{CC} = 3.3 \text{ V}$ .

<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

<sup>[3]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

# Triple non-inverting Schmitt trigger with 5 V tolerant input

# 13. Waveforms



Measurement points are given in Table 9.

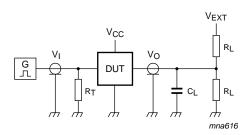
 $V_{\mbox{\scriptsize OL}}$  and  $V_{\mbox{\scriptsize OH}}$  are typical output voltage levels that occur with the output load.

Fig 8. The input (nA) to output (nY) propagation delays and the output transition times

Table 9. Measurement points

Supply voltage	Input	Output
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>
1.65 V to 1.95 V	$0.5 \times V_{CC}$	0.5 × V <sub>CC</sub>
2.3 V to 2.7 V	$0.5 \times V_{CC}$	0.5 × V <sub>CC</sub>
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	$0.5 \times V_{CC}$	0.5 × V <sub>CC</sub>

# Triple non-inverting Schmitt trigger with 5 V tolerant input



Test data is given in Table 10.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input	Input		Load		V <sub>EXT</sub>		
V <sub>CC</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	$t_{PZL}, t_{PLZ}$	
1.65 V to 1.95 V	$V_{CC}$	≤ 2.0 ns	30 pF	1 kΩ	open	GND	$2\times V_{CC}$	
2.3 V to 2.7 V	$V_{CC}$	≤ 2.0 ns	30 pF	$500 \Omega$	open	GND	$2\times V_{CC}$	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	GND	6 V	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	GND	6 V	
4.5 V to 5.5 V	V <sub>CC</sub>	≤ 2.5 ns	50 pF	$500~\Omega$	open	GND	$2\times V_{CC}$	

# Triple non-inverting Schmitt trigger with 5 V tolerant input

# 14. Transfer characteristics

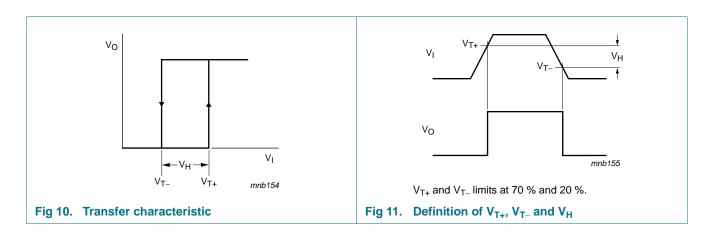
Table 11. Transfer characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

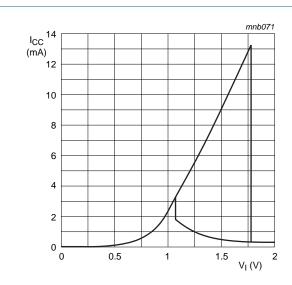
Symbol	Parameter	Conditions	-40	°C to +85	S °C	–40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
$V_{T+}$	positive-going	see Figure 10 and Figure 11						
	threshold voltage	$V_{CC} = 1.8 \text{ V}$	0.70	1.10	1.50	0.70	1.70	V
		$V_{CC} = 2.3 \text{ V}$	1.00	1.40	1.80	1.00	2.00	V
		$V_{CC} = 3.0 \text{ V}$	1.30	1.76	2.20	1.30	2.40	V
		V <sub>CC</sub> = 4.5 V	1.90	2.47	3.10	1.90	3.30	V
		V <sub>CC</sub> = 5.5 V	2.20	2.91	3.60	2.20	3.80	V
$V_{T-}$	negative-going threshold voltage	see Figure 10 and Figure 11						
		V <sub>CC</sub> = 1.8 V	0.25	0.61	0.90	0.25	1.10	V
		V <sub>CC</sub> = 2.3 V	0.40	0.80	1.15	0.40	1.35	V
		V <sub>CC</sub> = 3.0 V	0.60	1.04	1.50	0.60	1.70	V
		V <sub>CC</sub> = 4.5 V	1.00	1.55	2.00	1.00	2.20	V
		V <sub>CC</sub> = 5.5 V	1.20	1.86	2.30	1.20	2.50	V
$V_{H}$	hysteresis voltage	(V <sub>T+</sub> – V <sub>T</sub> ); see <u>Figure 10</u> , <u>Figure 11</u> and <u>Figure 12</u>						
		V <sub>CC</sub> = 1.8 V	0.15	0.49	1.00	0.15	1.20	V
		V <sub>CC</sub> = 2.3 V	0.25	0.60	1.10	0.25	1.30	V
		$V_{CC} = 3.0 \text{ V}$	0.40	0.73	1.20	0.40	1.40	V
		V <sub>CC</sub> = 4.5 V	0.60	0.92	1.50	0.60	1.70	V
		V <sub>CC</sub> = 5.5 V	0.70	1.02	1.70	0.70	1.90	V

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

# 15. Waveforms transfer characteristics

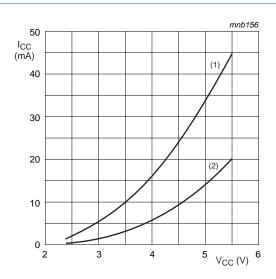


# Triple non-inverting Schmitt trigger with 5 V tolerant input



 $V_{CC} = 3.0 \text{ V}.$ 

Fig 12. Typical transfer characteristic



- (1) Positive-going edge.
- (2) Negative-going edge.

Linear change of  $V_{\rm I}$  between 0.8 V to 2.0 V. All values given are typical unless otherwise specified.

Fig 13. Average  $I_{\text{CC}}$  as a function of  $V_{\text{CC}}$ 

# Triple non-inverting Schmitt trigger with 5 V tolerant input

# 16. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

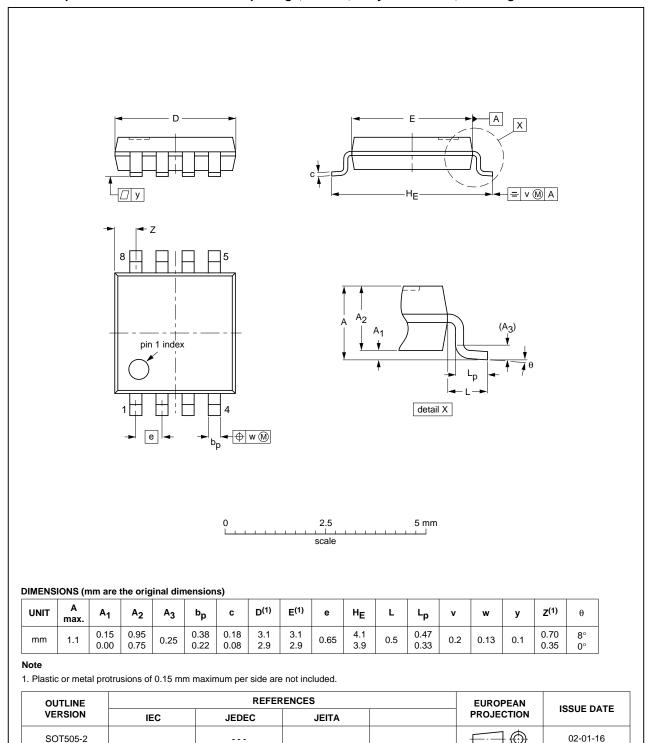


Fig 14. Package outline SOT505-2 (TSSOP8)

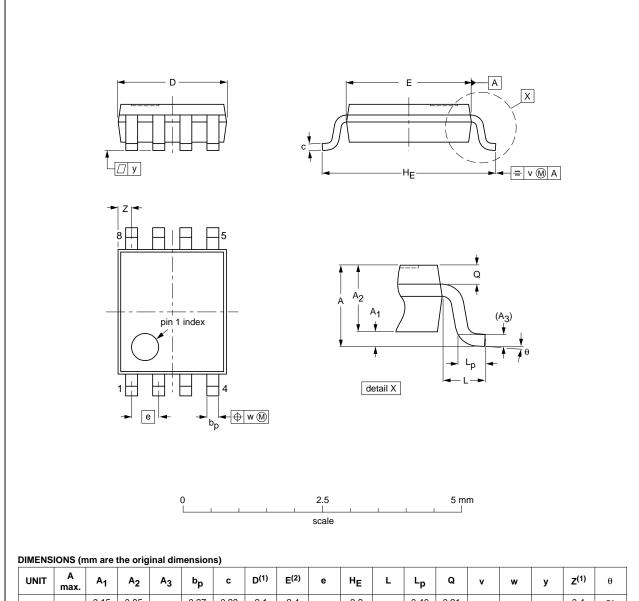
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74LVC3G17 **NXP Semiconductors** 

#### Triple non-inverting Schmitt trigger with 5 V tolerant input

#### VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1	0.15 0.00	0.85 0.60	0.12	0.27 0.17	0.23 0.08	2.1 1.9	2.4 2.2	0.5	3.2 3.0	0.4	0.40 0.15	0.21 0.19	0.2	0.13	0.1	0.4 0.1	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT765-1		MO-187				02-06-07	

Fig 15. Package outline SOT765-1 (VSSOP8)

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#### Triple non-inverting Schmitt trigger with 5 V tolerant input

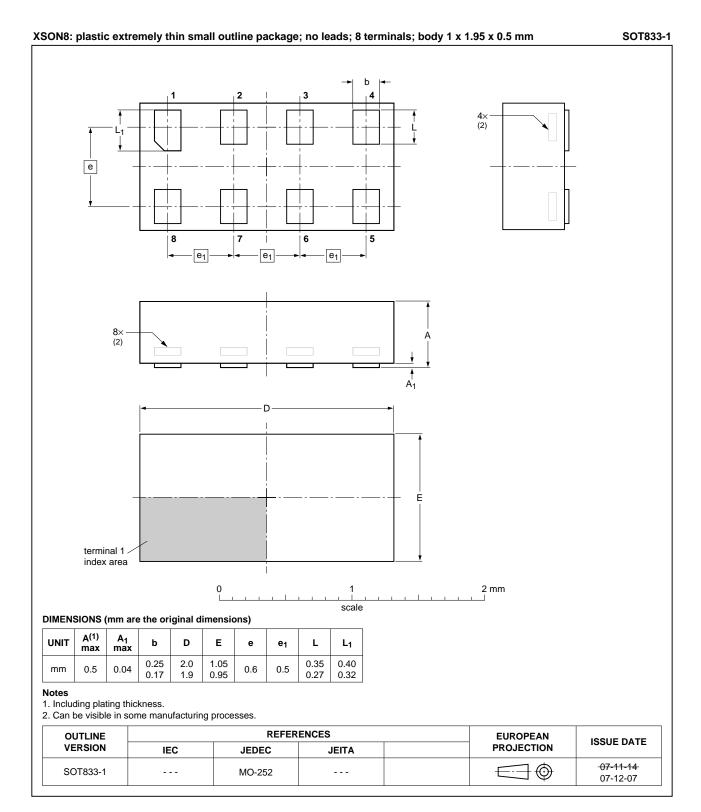


Fig 16. Package outline SOT833-1 (XSON8)

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#### Triple non-inverting Schmitt trigger with 5 V tolerant input

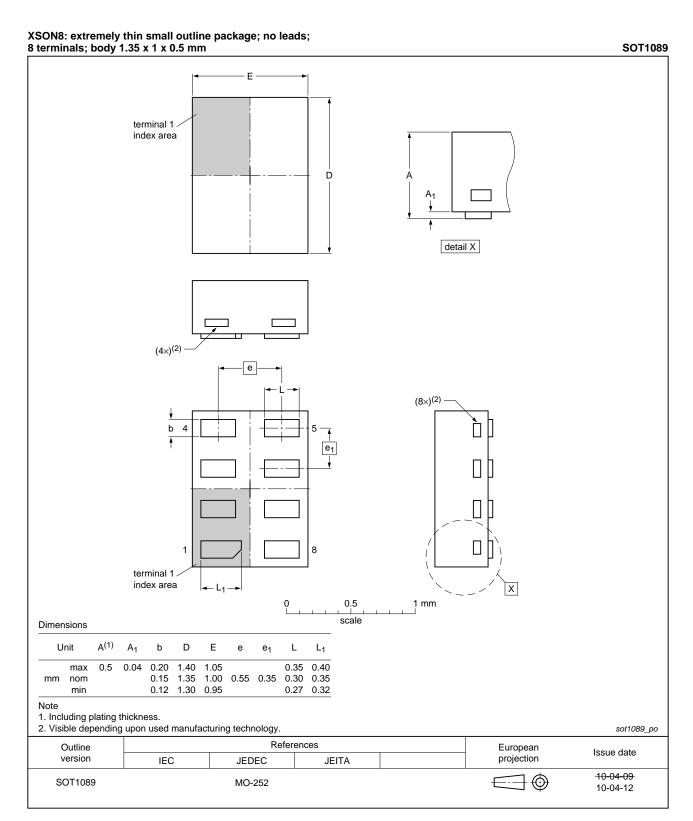


Fig 17. Package outline SOT1089 (XSON8)

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# Triple non-inverting Schmitt trigger with 5 V tolerant input

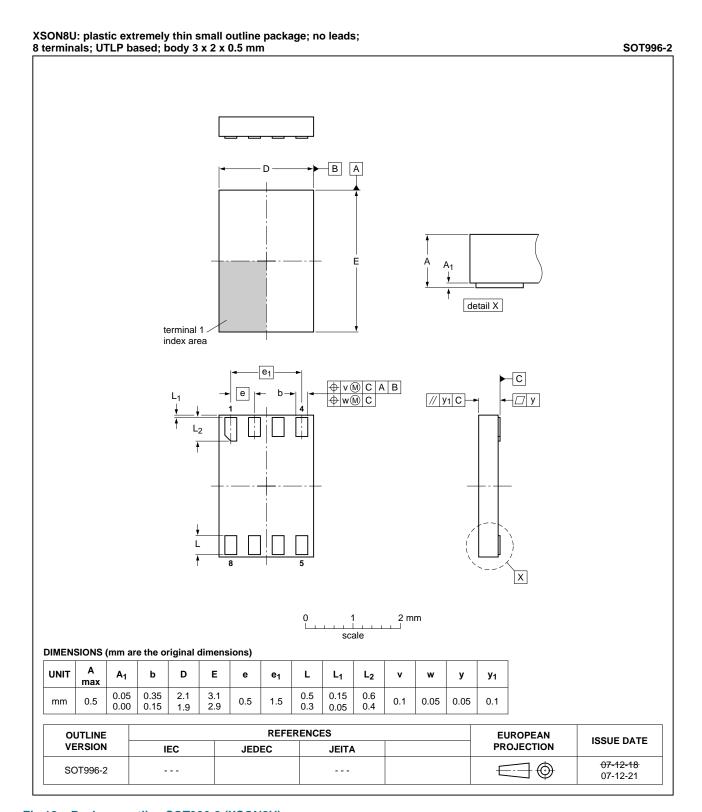


Fig 18. Package outline SOT996-2 (XSON8U)

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#### Triple non-inverting Schmitt trigger with 5 V tolerant input

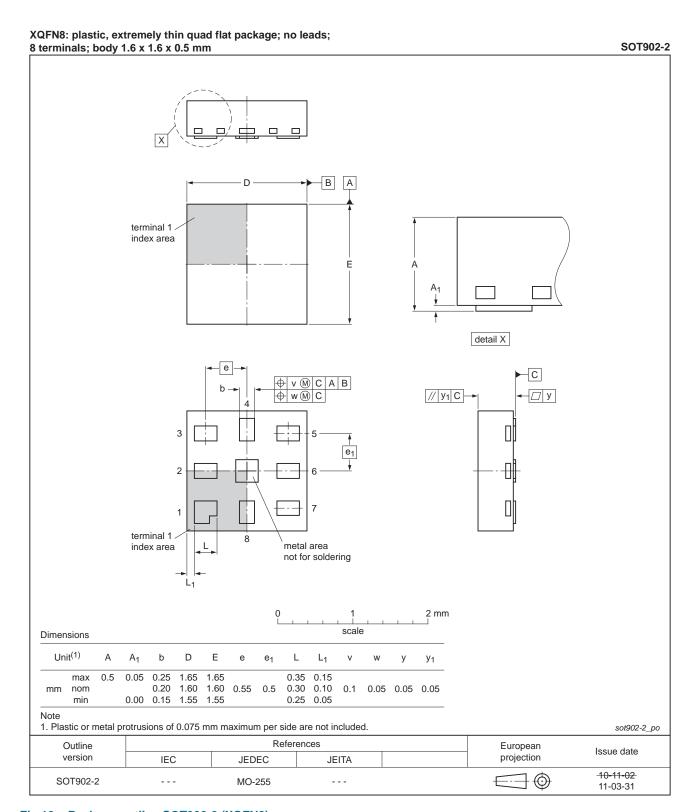


Fig 19. Package outline SOT902-2 (XQFN8)

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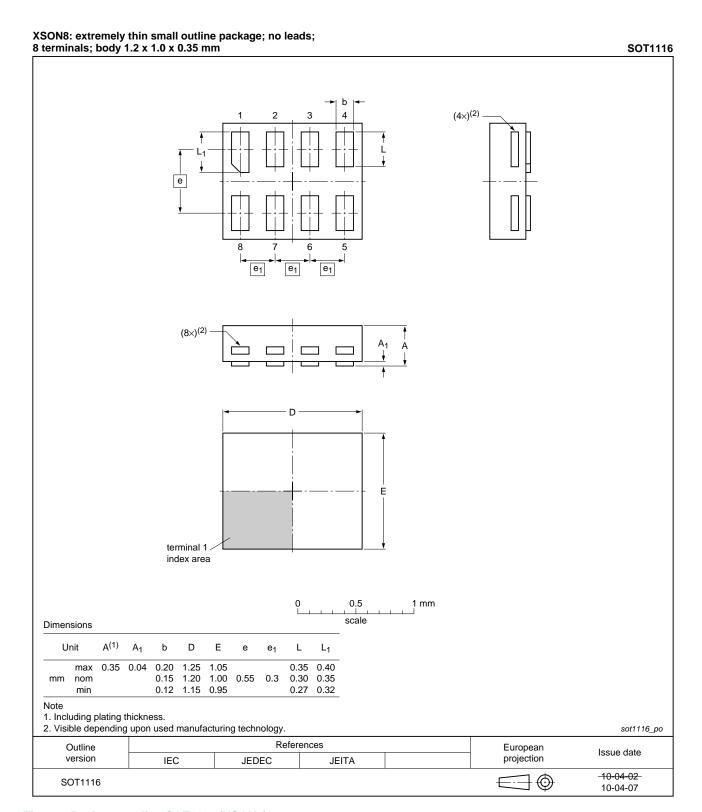


Fig 20. Package outline SOT1116 (XSON8)

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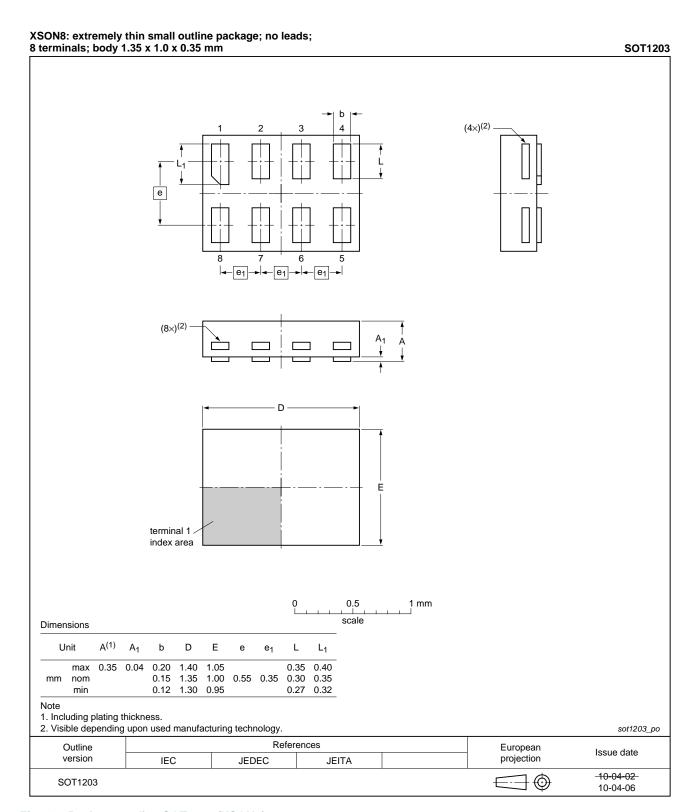


Fig 21. Package outline SOT1203 (XSON8)

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# Triple non-inverting Schmitt trigger with 5 V tolerant input

# 17. Abbreviations

#### Table 12. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 18. Revision history

#### Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC3G17 v.10	20120706	Product data sheet	-	74LVC3G17 v.9
Modifications:	<ul> <li>For type nu</li> </ul>	mber 74LVC3G17GM the S	OT code has changed	to SOT902-2.
74LVC3G17 v.9	20111123	Product data sheet	-	74LVC3G17 v.8
Modifications:	<ul> <li>Legal pages</li> </ul>	s updated.		
74LVC3G17 v.8	20110921	Product data sheet	-	74LVC3G17 v.7
74LVC3G17 v.7	20101104	Product data sheet	-	74LVC3G17 v.6
74LVC3G17 v.6	20080606	Product data sheet	-	74LVC3G17 v.5
74LVC3G17 v.5	20080313	Product data sheet	-	74LVC3G17 v.4
74LVC3G17 v.4	20070521	Product data sheet	-	74LVC3G17 v.3
74LVC3G17 v.3	20050131	Product data sheet	-	74LVC3G17 v.2
74LVC3G17 v.2	20041103	Product specification	-	74LVC3G17 v.1
74LVC3G17 v.1	20040624	Product specification	-	-

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# 19. Legal information

#### 19.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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